8-Input Multiplexer with 3-State Outputs

The TTL/MSI SN74LS251 is a high speed 8-Input Digital Multiplexer. It provides, in one package, the ability to select one bit of data from up to eight sources. The LS251 can be used as a universal function generator to generate any logic function of four variables. Both assertion and negation outputs are provided.

- Schottky Process for High Speed
- Multifunction Capability
- On-Chip Select Logic Decoding
- Inverting and Non-Inverting 3-State Outputs
- Input Clamp Diodes Limit High Speed Termination Effects

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-2.6	mA
I _{OL}	Output Current – Low			24	mA



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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 648

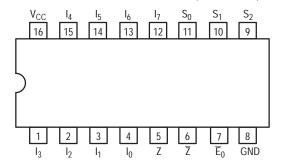


SOIC D SUFFIX CASE 751B

ORDERING INFORMATION

Device	Package	Shipping 2000 Units/Box		
SN74LS251N	16 Pin DIP			
SN74LS251D	16 Pin	2500/Tape & Reel		

CONNECTION DIAGRAM DIP (TOP VIEW)

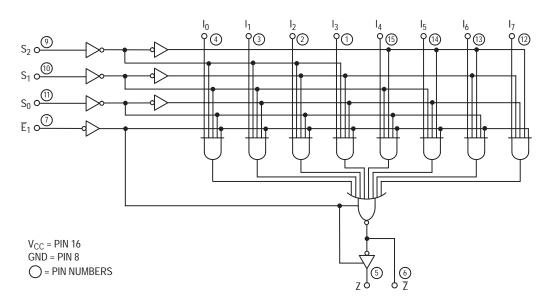


		LOADING (Note a)	
PIN NAMES		HIGH	LOW
$S_0 - S_2$ \overline{E}_0 $I_0 - I_7$ Z \overline{Z}	Select Inputs Output Enable (Active LOW) Inputs Multiplexer Inputs Multiplexer Output Complementary Multiplexer Output	0.5 U.L. 0.5 U.L. 0.5 U.L. 65 U.L. 65 U.L.	0.25 U.L. 0.25 U.L. 0.25 U.L. 15 U.L. 15 U.L.

NOTES:

a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

LOGIC DIAGRAM



FUNCTIONAL DESCRIPTION

The LS251 is a logical implementation of a single pole, 8-position switch with the switch position controlled by the state of three Select inputs, S_0 , S_1 , S_2 . Both assertion and negation outputs are provided. The Output Enable input (\overline{E}_O) is active LOW. When it is activated, the logic function provided at the output is:

$$\begin{split} Z &= \overline{E}_O \cdot (I_O \cdot \overline{S}_O \cdot \overline{S}_1 \cdot \overline{S}_2 + I_1 \cdot S_O \cdot \overline{S}_1 \cdot \overline{S}_2 + I_2 \cdot \overline{S}_O \cdot S_1 \cdot \\ & \overline{S}_2 + I_3 \cdot S_O \cdot S_1 \cdot \overline{S}_2 + I_4 \cdot \overline{S}_O \cdot \overline{S}_1 \cdot S_2 + I_5 \cdot S_O \cdot \\ & \overline{S}_1 \cdot S_2 + I_6 \cdot \overline{S}_O \cdot S_1 \cdot S_2 + I_7 \cdot S_O \cdot S_1 \cdot S_2). \end{split}$$

When the Output Enable is HIGH, both outputs are in the high impedance (high Z) state. This feature allows multiplexer expansion by tying the outputs of up to 128 devices together. When the outputs of the 3-state devices are tied together, all but one device must be in the high impedance state to avoid high currents that would exceed the maximum ratings. The Output Enable signals should be designed to ensure there is no overlap in the active LOW portion of the enable voltage.

TRUTH TABLE

Ē₀	S ₂	S ₁	S ₀	I ₀	I ₁	l ₂	l ₃	I ₄	l ₅	I ₆	I ₇	Z	Z
Н	Х	Х	Χ	Х	Χ	Х	Χ	Х	Χ	Χ	Χ	(Z)	(Z)
L	L	L	L	L	Χ	Χ	Χ	Χ	X	X	X	Н	L
L	L	L	L	Н	Χ	Χ	Χ	Χ	Χ	X	X	L	Н
L	L	L	Н	Х	L	Χ	Χ	Χ	Χ	X	X	Н	L
L	L	L	Н	Х	Н	Χ	Χ	Χ	X	X	X	L	Н
L	L	Н	L	Х	Χ	L	Χ	Χ	Χ	X	X	Н	L
L	L	Н	L	Х	Χ	Н	Χ	Χ	Χ	X	X	L	Н
L	L	Н	Н	Х	Χ	Χ	L	Χ	Χ	X	X	Н	L
L	L	Н	Н	Х	Χ	Χ	Н	Χ	Χ	X	X	L	Н
L	Н	L	L	Х	Χ	Χ	Χ	L	Χ	Χ	X	Н	L
L	Н	L	L	Х	Χ	Χ	Χ	Н	Χ	Χ	X	L	Н
L	Н	L	Н	Х	Χ	Χ	Χ	Χ	L	X	X	Н	L
L	Н	L	Н	Х	Χ	Χ	Χ	Χ	Н	X	X	L	Н
L	Н	Н	L	Х	Χ	Χ	Χ	Χ	Χ	L	X	Н	L
L	Н	Н	L	Х	X	X	Χ	Χ	X	Н	X	L	Н
L	Н	Н	Н	Х	Χ	Χ	Χ	Χ	Χ	Χ	L	Н	L
L	Н	Н	Н	Х	Χ	Χ	Χ	Χ	Χ	Χ	Н	L	Н

H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

⁽Z) = High impedance (Off)

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions		
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Inpu All Inputs	t HIGH Voltage for	
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Inpu All Inputs	t LOW Voltage for	
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	٧	V _{CC} = MIN, I _{IN} =	–18 mA	
V _{OH}	Output HIGH Voltage	2.4	3.1		V	$V_{CC} = MIN$, $I_{OH} = MAX$, $V_{IN} = V_{IH}$ or V_{IL} per Truth Table		
.,	0		0.25	0.4	٧	I _{OL} = 12 mA	$V_{CC} = V_{CC} MIN,$	
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 24 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table	
I _{OZH}	Output Off Current HIGH			20	μΑ	V _{CC} = MAX, V _{OUT} = 2.7 V		
I _{OZL}	Output Off Current LOW			-20	μΑ	$V_{CC} = MAX, V_{OU}$	T = 0.4 V	
	Innut IIICI I Current			20	μА	V _{CC} = MAX, V _{IN} = 2.7 V		
IH	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V		
I _{IL}	Input LOW Current			-0.4	mA	$V_{CC} = MAX$, $V_{IN} = 0.4 V$		
I _{OS}	Short Circuit Current (Note 1)	-30		-130	mA	V _{CC} = MAX		
	Dower Cumply Cumpant			10	mA	$V_{CC} = MAX, V_{E} = 0 V$		
Icc	Power Supply Current			12	mA	$V_{CC} = MAX, V_{E} =$	= 4.5 V	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS ($T_A = 25^{\circ}C$, $V_{CC} = 5.0 \text{ V}$)

		Limits						
Symbol	Parameter	Min	Тур	Max	Unit	Test	Conditions	
t _{PLH} t _{PHL}	Propagation Delay, Select to ℤ Output		20 21	33 33	ns	Figure 1		
t _{PLH} t _{PHL}	Propagation Delay, Select to Z Output		29 28	45 45	ns	Figure 2		
t _{PLH} t _{PHL}	Propagation Delay, Data to ℤ Output		10 9.0	15 15	ns	Figure 1	C _L = 15 pF,	
t _{PLH} t _{PHL}	Propagation Delay, Data to Z Output		17 18	28 28	ns	Figures 2	$R_L = 2.0 \text{ k}\Omega$	
t _{PZH} t _{PZL}	Output Enable Time to Z̄ Output		17 24	27 40	ns	Figures 4, 5		
t _{PZH} t _{PZL}	Output Enable Time to Z Output		30 26	45 40	ns	Figures 3, 5		
t _{PHZ} t _{PLZ}	Output Disable Time to Z Output		37 15	55 25	ns	Figures 3, 5	$C_L = 5.0 pF,$	
t _{PHZ} t _{PLZ}	Output Disable Time to Z Output		30 15	45 25	ns	Figures 4, 5	$R_L = 667 \text{ k}\Omega$	

3-STATE AC WAVEFORMS

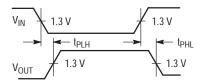


Figure 1.

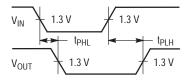


Figure 2.

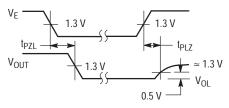


Figure 3.

0.5 V

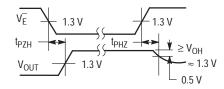
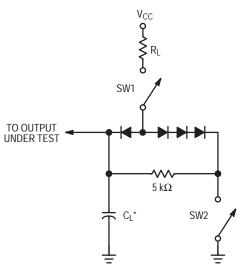


Figure 4.

AC LOAD CIRCUIT



* Includes Jig and Probe Capacitance.

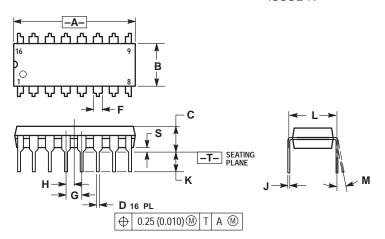
SWITCH POSITIONS

SYMBOL	SW1	SW2	
t _{PZH}	Open	Closed	
t_{PZL}	Closed	Open	
t_{PLZ}	Closed	Closed	
t _{PHZ}	Closed	Closed	

Figure 5.

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 648-08 ISSUE R

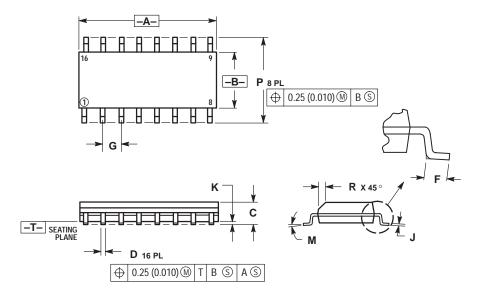


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.015 0.021		0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295 0.305		7.50	7.74	
М	0°	10 °	0°	10 °	
S	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS

D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 **ISSUE J**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	ERS INCHE				
DIM	MIN	MAX	MIN	MAX			
Α	9.80	10.00	0.386	0.393			
В	3.80	4.00	0.150	0.157			
С	1.35	1.75	0.054	0.068			
D	0.35	0.49	0.014	0.019			
F	0.40	1.25	0.016	0.049			
G	1.27	BSC	0.050	BSC			
J	0.19	0.25	0.008	0.009			
K	0.10	0.25	0.004	0.009			
M	0 °	7°	0°	7°			
Р	5.80	6.20	0.229	0.244			
R	0.25	0.50	0.010	0.019			

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